

RoHS

ECN NO.

REV

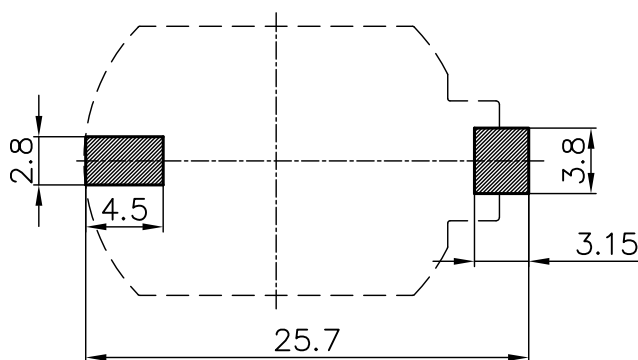
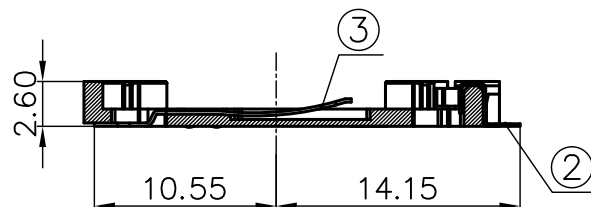
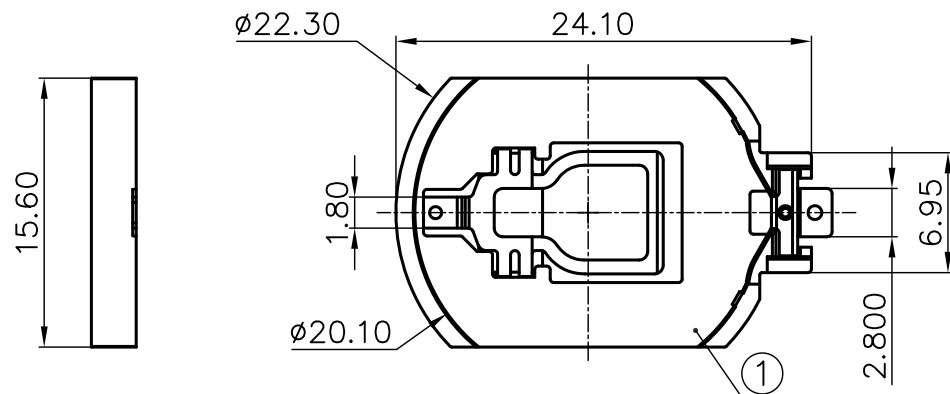
DATE

DESCRIPTION

CHANGE

CHECK

APPRO

PCB Layout Diagram
Top View

NOTE:

1.MATERIAL:

a.HOUSING:PPA

b.CONTACT:PHOSPHOR BRONZE

(SURFACE PLATING: Au1u")

SEE ORDERING INFORMATION

2.ELECTRIC:

a.CONTACT RESISTANCE: 30 MILLIOHMS MAX

b.INSULATION RESISTANCE: 100 MEGA OHMS MIN

c.DIELECTNIC VOLTAGE: 500V AC ONE SEC LEVEL

d.OPERATING TEMPERATURE: -25° C~ +85° C

UNLESS OTHERWISE
SPECIFIED TOLERANCESDECIMALS: ANGLES:
X :±0.30 X :±1°
X.X :±0.25 X.X:±0.5°
X.XX :±0.20
X.XXX:±0.10

WEIGHT:0.66g

SHEET 1 OF 1

MeiYang Electronics Co.Ltd

DSND

DATE

TITLE:

CHKD

DATE

BS-2016-8-1 SMT

APVD

DATE

PART NO.:

SCALE:2:1

SIZE:A4

VIEW:

BS-2016-B2AA001

UNIT:mm

REV.:A/0

OBJECT:MY

DRAW NO.:MY-CP-0029

③	TERMINAL(-)	1	PHOSPHOR BRONZE, T=0.20mm	Gold Plating and Ni Under-Plating
②	TERMINAL(+)	1	PHOSPHOR BRONZE, T=0.15mm	Gold Plating and Ni Under-Plating
①	HOUSING	1	PPA	BROWN

NO.	PART NAME	Q'TY	MATERIAL	PLATING & COLOR
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